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**Identification cards — Contactless
integrated circuit cards — Proximity
cards —**

**Part 3:
Initialization and anticollision**

*Cartes d'identification — Cartes à circuit intégré sans contact —
Cartes de proximité —*

Partie 3: Initialisation et anticollision

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Contents

Page

Foreword	v
Introduction	vi
1 Scope	1
2 Normative references	1
3 Terms and definitions	2
4 Symbols and abbreviated terms	3
5 Initial dialogs	4
5.1 Alternating PICC and PCD support (PXD)	4
5.2 Alternating between Type A and Type B commands	5
5.2.1 Polling	5
5.2.2 Influence of Type A commands on PICC Type B operation	5
5.2.3 Influence of Type B commands on PICC Type A operation	6
5.2.4 Transition to POWER-OFF state	6
6 Type A — Initialization and anticollision	6
6.1 etu	6
6.2 Frame format and timing	6
6.2.1 Frame delay time	7
6.2.2 Request Guard Time	8
6.2.3 Frame formats	8
6.2.4 CRC_A	11
6.3 PICC states	12
6.3.1 POWER-OFF state	13
6.3.2 IDLE state	14
6.3.3 READY state	14
6.3.4 ACTIVE state	14
6.3.5 HALT state	14
6.3.6 READY* state	14
6.3.7 ACTIVE* state	14
6.3.8 PROTOCOL state	15
6.4 Command set	15
6.4.1 REQA and WUPA commands	15
6.4.2 ANTICOLLISION and SELECT commands	16
6.4.3 HLTA command	16
6.5 Select sequence	16
6.5.1 Select sequence flowchart	16
6.5.2 ATQA — Answer to Request	17
6.5.3 Anticollision and Select	18
6.5.4 UID contents and cascade levels	22
7 Type B — Initialization and anticollision	24
7.1 Character, frame format and timing	24
7.1.1 Character transmission format	24
7.1.2 Character separation	24
7.1.3 Frame format	25
7.1.4 SOF	25
7.1.5 EOF	26
7.1.6 Timing before the PICC SOF	27
7.1.7 Timing before the PCD SOF	27
7.2 CRC_B	28
7.3 Anticollision sequence	28
7.4 PICC states description	29
7.4.1 Initialization and anticollision flowchart	31
7.4.2 General statement for state description and transitions	31

7.4.3	POWER-OFF state.....	32
7.4.4	IDLE state.....	32
7.4.5	READY-REQUESTED sub-state.....	32
7.4.6	READY-DECLARED sub-state.....	32
7.4.7	PROTOCOL state.....	33
7.4.8	HALT state.....	33
7.5	Command set.....	33
7.6	Anticollision response rules.....	34
7.6.1	PICC with initialization only.....	34
7.7	REQB/WUPB command.....	34
7.7.1	REQB/WUPB command format.....	34
7.7.2	Coding of anticollision prefix byte APf.....	34
7.7.3	Coding of AFI.....	35
7.7.4	Coding of PARAM.....	35
7.8	Slot-MARKER command.....	36
7.8.1	Slot-MARKER command format.....	36
7.8.2	Coding of anticollision prefix byte APn.....	37
7.9	ATQB Response.....	37
7.9.1	ATQB response format.....	37
7.9.2	PUPI (Pseudo-Unique PICC Identifier).....	38
7.9.3	Application data.....	38
7.9.4	Protocol Info.....	38
7.10	ATTRIB command.....	42
7.10.1	ATTRIB command format.....	42
7.10.2	Identifier.....	42
7.10.3	Coding of Param 1.....	42
7.10.4	Coding of Param 2.....	44
7.10.5	Coding of Param 3.....	44
7.10.6	Coding of Param 4.....	45
7.10.7	Higher layer INF.....	45
7.11	Answer to ATTRIB command.....	45
7.12	HLTB command and Answer.....	46
8	Electromagnetic disturbance handling.....	47
8.1	General.....	47
8.2	EMD handling timing constraints.....	47
8.3	Recommendations for a PCD EMD handling algorithm.....	48
Annex A	(informative) Communication example Type A.....	49
Annex B	(informative) CRC_A and CRC_B encoding.....	51
Annex C	(informative) Type A timeslot — Initialization and anticollision.....	54
Annex D	(informative) Example of Type B Anticollision Sequence.....	58
Annex E	(normative) Bit rates of $3fc/4$, fc, $3fc/2$ and $2fc$ from PCD to PICC.....	61
Bibliography	63

Foreword

ISO (the International Organization for Standardization) and IEC (the International Electrotechnical Commission) form the specialized system for worldwide standardization. National bodies that are members of ISO or IEC participate in the development of International Standards through technical committees established by the respective organization to deal with particular fields of technical activity. ISO and IEC technical committees collaborate in fields of mutual interest. Other international organizations, governmental and non-governmental, in liaison with ISO and IEC, also take part in the work. In the field of information technology, ISO and IEC have established a joint technical committee, ISO/IEC JTC 1.

The procedures used to develop this document and those intended for its further maintenance are described in the ISO/IEC Directives, Part 1. In particular the different approval criteria needed for the different types of document should be noted. This document was drafted in accordance with the editorial rules of the ISO/IEC Directives, Part 2 (see www.iso.org/directives).

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For an explanation on the meaning of ISO specific terms and expressions related to conformity assessment, as well as information about ISO's adherence to the WTO principles in the Technical Barriers to Trade (TBT) see the following URL: [Foreword - Supplementary information](#)

The committee responsible for this document is ISO/IEC JTC 1, *Information technology*, Subcommittee SC 17, *Identification cards and related devices*.

This third edition cancels and replaces the second edition (ISO/IEC 14443-3:2011), which has been technically revised. It also incorporates the Amendments ISO/IEC 14443-3:2011/Amd 1:2011, ISO/IEC 14443-3:2011/Amd 2:2012, ISO/IEC 14443-3:2011/Amd 3:2014 and ISO/IEC 14443-3:2011/Amd 6:2014.

ISO/IEC 14443 consists of the following parts, under the general title *Identification cards — Contactless integrated circuit cards — Proximity cards*:

- *Part 1: Physical characteristics*
- *Part 2: Radio frequency power and signal interface*
- *Part 3: Initialization and anti-collision*
- *Part 4: Transmission protocol*

This corrected version of ISO/IEC 14443-3:2016 incorporates the following correction.

Figure 4 was corrected: The last parity bit of a PICC standard frame with bit rate higher than $f_c/128$ was changed from “odd” to “even”.

Introduction

ISO/IEC 14443 is one of a series of International Standards describing the parameters for identification cards as defined in ISO/IEC 7810 and the use of such cards for international interchange.

This part of ISO/IEC 14443 describes polling for proximity cards entering the field of a proximity coupling device, the byte format and framing, the initial Request and Answer to Request command content, methods to detect and communicate with one proximity card among several proximity cards (anticollision) and other parameters required to initialize communications between a proximity card and a proximity coupling device. Protocols and commands used by higher layers and by applications and which are used after the initial phase are described in ISO/IEC 14443-4.

ISO/IEC 14443 is intended to allow operation of proximity cards in the presence of other contactless cards conforming to ISO/IEC 10536 and ISO/IEC 15693.

Identification cards — Contactless integrated circuit cards — Proximity cards —

Part 3: Initialization and anticollision

1 Scope

This part of ISO/IEC 14443 describes the following:

- polling for proximity cards or objects (PICCs) entering the field of a proximity coupling device (PCD);
- the byte format, the frames and timing used during the initial phase of communication between PCDs and PICCs;
- the initial Request and Answer to Request command content;
- methods to detect and communicate with one PICC among several PICCs (anticollision);
- other parameters required to initialize communications between a PICC and PCD;
- optional means to ease and speed up the selection of one PICC among several PICCs based on application criteria;
- optional capability to allow a device to alternate between the functions of a PICC and a PCD to communicate with a PCD or a PICC, respectively. A device which implements this capability is called a PXD.

Protocol and commands used by higher layers and by applications and which are used after the initial phase are described in ISO/IEC 14443-4.

This part of ISO/IEC 14443 is applicable to PICCs of Type A and of Type B (as described in ISO/IEC 14443-2) and PCDs (as described in ISO/IEC 14443-2) and to PXDs.

NOTE 1 Part of the timing of data communication is defined in ISO/IEC 14443-2.

NOTE 2 Test methods for this part of ISO/IEC 14443 are defined in ISO/IEC 10373-6.

2 Normative references

The following documents, in whole or in part, are normatively referenced in this document and are indispensable for its application. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

ISO/IEC 7816-4, *Identification cards — Integrated circuit cards — Part 4: Organization, security and commands for interchange*

ISO/IEC 7816-6, *Identification cards — Integrated circuit cards — Part 6: Interindustry data elements for interchange*

ISO/IEC 13239, *Information technology — Telecommunications and information exchange between systems — High-level data link control (HDLC) procedures*

ISO/IEC 14443-2, *Identification cards — Contactless integrated circuit cards — Proximity cards — Part 2: Radio frequency power and signal interface*

3 Terms and definitions

For the purposes of this document, the terms and definitions given in ISO/IEC 14443-2 and the following apply.

3.1 **anticollision loop**

algorithm used to prepare for dialogue between PCD and one or more PICCs out of the total number of PICCs responding to a request command

3.2 **byte**

byte consisting of 8 bits of data designated b8 to b1, from the most significant bit (MSB, b8) to the least significant bit (LSB, b1)

3.3 **collision**

transmission by two PICCs in the same PCD energizing field and during the same time period, such that the PCD is unable to distinguish from which PICC the data originated

3.4 **frame**

sequence of data bits and optional error detection bits, with frame delimiters at start and end

3.5 **frame error**

error on SOF, start and stop bits, parity bits, EOF

3.6 **higher layer protocol**

protocol layer (not described in this part of ISO/IEC 14443) that makes use of the protocol layer defined in this part of ISO/IEC 14443 to transfer information belonging to the application or higher layers of protocol that is not described in this part of ISO/IEC 14443

3.7 **PCD Mode**

mode in which a PCD operates as a PCD

3.8 **PICC Mode**

mode in which a PCD operates as a PICC

3.9 **request command**

command requesting PICCs of the appropriate type to respond if they are available for initialization

3.10 **transmission error**

frame error or CRC_A or CRC_B error